BT151S series

BT151M series

GENERAL DESCRIPTION

Passivated thyristors in a plastic envelope, suitable for surface mounting, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

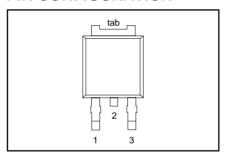
QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V _{DRM} , V _{RRM} I _{T(AV)} I _{T(RMS)} I _{TSM}	BT151S (or BT151M)- Repetitive peak off-state voltages Average on-state current RMS on-state current Non-repetitive peak on-state current	500R 500 7.5 12 100	650R 650 7.5 12 100	800R 800 7.5 12 100	V A A A

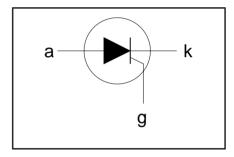
PINNING - SOT428

PIN NUMBER	Standard S	Alternative M
1	cathode	gate
2	anode	anode
3	gate	cathode
tab	anode	anode

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
V_{DRM}, V_{RRM}	Repetitive peak off-state voltages		-	-500R 500 ¹	-650R 650 ¹	-800R 800	V
I _{T(AV)} I _{T(RMS)} I _{TSM}	Average on-state current RMS on-state current Non-repetitive peak on-state current	half sine wave; $T_{mb} \le 103$ °C all conduction angles half sine wave; $T_j = 25$ °C prior to surge	-		7.5 12		A A
	on state surrent	t = 10 ms t = 8.3 ms	-		100 110		A A
l ² t	I ² t for fusing	t = 10 ms	-		50		A A ² s
dl _⊤ /dt	Repetitive rate of rise of on-state current after triggering	I_{TM} = 20 A; I_{G} = 50 mA; dI_{G}/dt = 50 mA/ μ s	-		50		A/μs
I _{GM}	Peak gate current		-		2		Α
$V_{\rm GM}$	Peak gate voltage		-		5		V
V _{RGM}	Peak reverse gate voltage Peak gate power		_		2 5 5 5		V W
P _{GM} P _{G(AV)}	Average gate power	over any 20 ms period	_		0.5		l w l
T _{stg}	Storage temperature Operating junction temperature	5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 - 5 -	-40 -		150 125		ာ့ သံ

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed 15 A/ μ s.

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Thyristors

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance			-	1.8	K/W
R _{th j-a}	junction to mounting base Thermal resistance junction to ambient	pcb (FR4) mounted; footprint as in Fig.14	-	75	-	K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{GT}	Gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$	-	2	15	mΑ
I _L	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$	-	10	40	mΑ
l I _H	Holding current	$V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$	-	7	20	mΑ
ĺΫ́τ	On-state voltage	$I_{T} = 23 \text{ A}$	-	1.4	1.75	V
V _{GT}	Gate trigger voltage	$\dot{V}_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}$	-	0.6	1.5	V
		$V_D = V_{DRM(max)}$; $I_T = 0.1 \text{ A}$; $T_j = 125 ^{\circ}\text{C}$	0.25	0.4	-	V
I_{D}, I_{R}	Off-state leakage current	$V_D = V_{DRM(max)}$; $V_R = V_{RRM(max)}$; $T_j = 125$ °C	-	0.1	0.5	mA

DYNAMIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of off-state voltage	$\begin{aligned} V_{\text{DM}} &= 67\% \ V_{\text{DRM(max)}}; T_{j} = 125 \ ^{\circ}\text{C}; \\ \text{exponential waveform;} \\ \text{Gate open circuit} \\ R_{\text{GK}} &= 100 \ \Omega \end{aligned}$	50 200	130 1000	- -	V/μs V/μs
t _{gt} t _q	Gate controlled turn-on time Circuit commutated turn-off time	$ \begin{aligned} &I_{TM} = 40 \text{ A; } V_D = V_{DRM(max)}; \ I_G = 0.1 \text{ A; } \\ &dI_G/dt = 5 \text{ A/}\mu\text{s} \\ &V_D = 67\% \ V_{DRM(max)}; \ T_j = 125 \ ^\circ\text{C; } \\ &I_{TM} = 20 \text{ A; } V_R = 25 \text{ V; } dI_{TM}/dt = 30 \text{ A/}\mu\text{s; } \\ &dV_D/dt = 50 \text{ V/}\mu\text{s; } R_{GK} = 100 \ \Omega \end{aligned} $	-	70	-	μs μs

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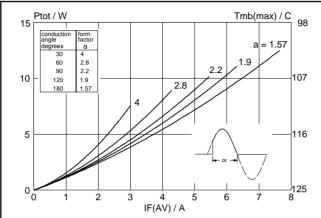


Fig.1. Maximum on-state dissipation, P_{tot} , versus average on-state current, $I_{T(AV)}$, where $a = form \ factor = I_{T(RMS)} / I_{T(AV)}$.

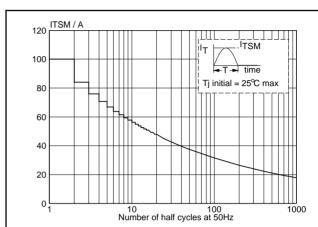


Fig.4. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, f = 50 Hz.

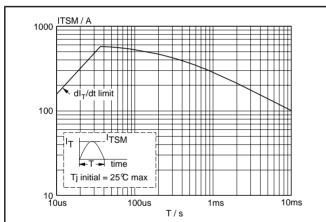


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \le 10$ ms.

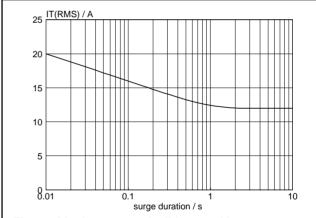


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{mb} \le 103$ °C.

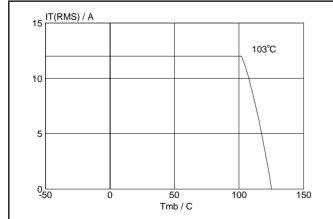


Fig.3. Maximum permissible rms current $I_{T(RMS)}$, versus mounting base temperature T_{mb} .

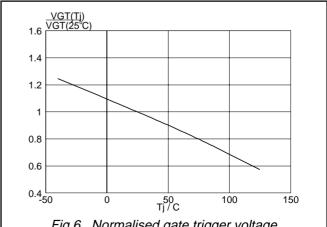
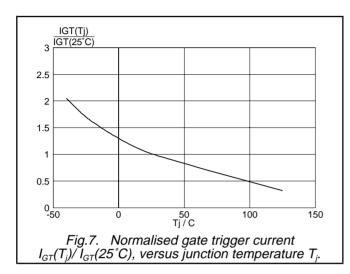


Fig.6. Normalised gate trigger voltage $V_{GT}(T_i)/V_{GT}(25^{\circ}C)$, versus junction temperature T_i .

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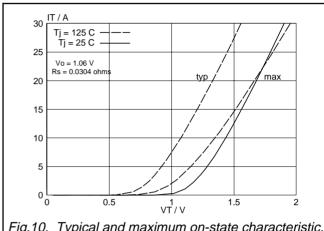
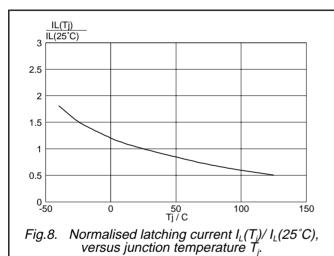


Fig. 10. Typical and maximum on-state characteristic.



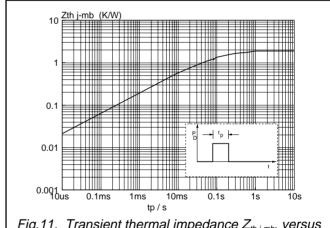
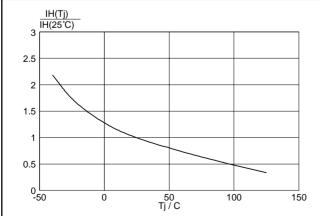


Fig.11. Transient thermal impedance $Z_{th i-mb}$, versus pulse width t_n.



Normalised holding current $I_H(T_i)/I_H(25^{\circ}C)$, versus junction temperature T_j .

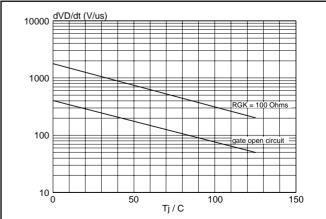
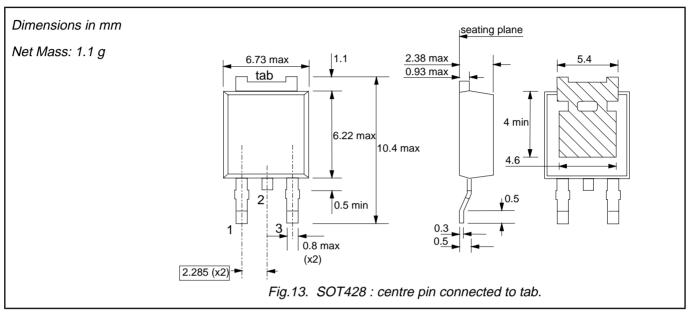


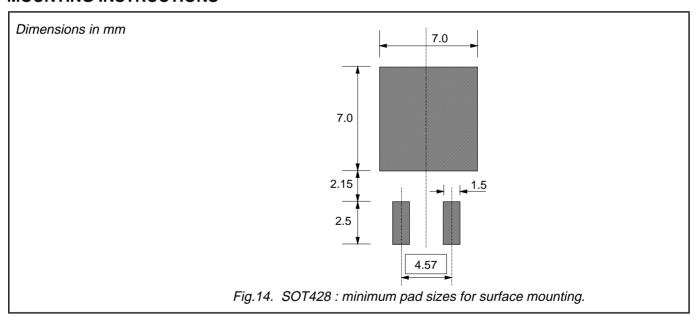
Fig.12. Typical, critical rate of rise of off-state voltage, $d\dot{V}_D/dt$ versus junction temperature T_{i}

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MECHANICAL DATA



MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

Thyristors

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DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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